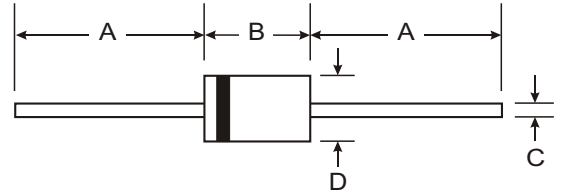
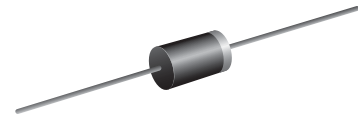


Features

- Miniature Size
- Low Forward Voltage drop
- Low Reverse Leakage Current
- High Surge Capability
- 52mm Inside Tape Spacing Package Available

Mechanical Data

- Case: DO - 41 Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.34 grams (approx.)
- Mounting Position: Any
- Marking: Type Number



DO-41		
Dim	Min	Max
A	25.40	—
B	4.06	5.21
C	0.71	0.864
D	2.00	2.72
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Rating	Symbol	10DDA40		Unit	
Repetitive Peak Reverse Voltage	V _{RRM}	400		V	
Average Rectified Output Current	I _O	50Hz Half Sine Wave Resistive Load	T _a =58°C *1	1.0	A
			T _l =132°C (T _l =Lead Temperature)		
RMS Forward Current	I _{F(RMS)}			1.57	A
Surge Forward Current	I _{FSM}	50Hz Half Sine Wave, 1cycle, Non-repetitive		45	A
Operating Junction Temperature Range	T _{jw}	- 40 to + 150			°C
Storage Temperature Range	T _{stg}	- 40 to + 150			°C

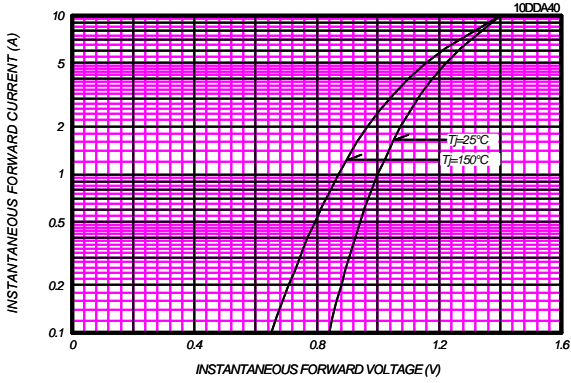
Characteristics	Symbol	Conditions	Min.	Typ.	Max.	Unit
Peak Reverse Current	I _{RM}	T _j = 25°C, V _{RM} = V _{RRM}	-	-	10	μA
Peak Forward Voltage	V _{FM}	T _j = 25°C, I _{FM} = 1.0A	-	-	1.0	v
Thermal Resistance	R _{th(j-a)}	Junction to Ambient *1			91	°C/W
	R _{th(j-l)}	Junction to Lead			17	

*1: Without Fin or P.C. Board mounted

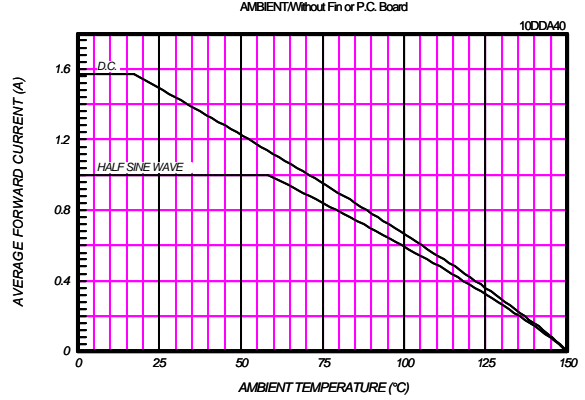


SUMMATE

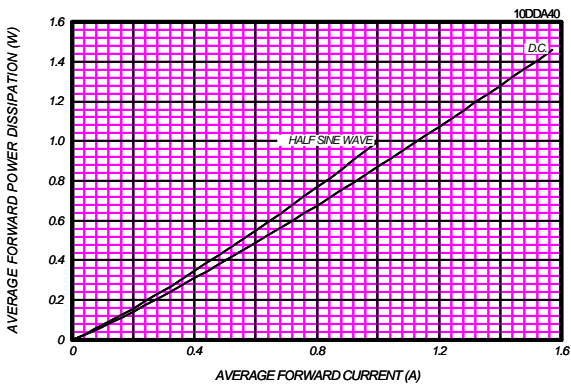
FORWARD CURRENT VS. VOLTAGE



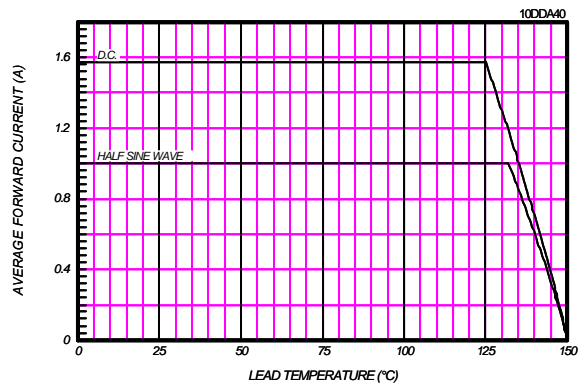
AVERAGE FORWARD CURRENT VS. AMBIENT TEMPERATURE



AVERAGE FORWARD POWER DISSIPATION



AVERAGE FORWARD CURRENT VS. LEAD TEMPERATURE



SURGE CURRENT RATINGS

f=50Hz, Half Sine Wave, Non-Repetitive, No Load

